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Substituted for form 1449A/PTO INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary)				COMPLETE IF KNOWN	
				Application Number	09/849,505
				Confirmation Number	8691
				Filing Date	May 4, 2001
				First Named Inventor	Gregory J. Wilson
				Group Art Unit	2121
Examiner Name	Unknown	RECEIVED MAR 22 2002 Technology Center 2100			
Attorney Docket No.	291958157US1				
1		of		1	

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*EXAMINER INITIALS	Cite No.	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		NUMBER	Kind Code (if known)			
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		Office	Number	Kind Code (if known)				

OTHER PRIOR ART-NON PATENT LITERATURE DOCUMENTS

*EXAMINER INITIALS	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume/issue number(s), publisher, city and/or country where published.	T
<i>RE</i>	AO	RITTER et al., "Two- And Three- Dimensional Numerical Modeling of Copper Electroplating For Advanced ULSI Metallization", E-MRS Conference, Symposium M, <i>Basic Models to Enhance Reliability</i> , Strasbourg (France), 1999	

EXAMINER

Randy Patel

DATE CONSIDERED

8/23/04

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